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# VOLTAGE PROTECTION FOR 2-, 3-, OR 4-CELL Li-lon BATTERIES (2<sup>nd</sup>-LEVEL PROTECTION)

#### **FEATURES**

- 2-, 3-, or 4-Cell Secondary Protection
- Low Power Consumption I<sub>CC</sub> < 2 μA [VCELL<sub>(ALL)</sub> < V<sub>(PROTECT)</sub>]
- Fixed High Accuracy Overvoltage Protection Threshold
  - bq29410 = 4.35 V
  - bq29411 = 4.40 V
  - bq29412 = 4.45 V
  - bq29413 = 4.50 V
  - bq29414 = 4.55 V
  - bq29415 = 4.60 V
  - bq29419 = 4.30 V
- Programmable Delay Time of Detection
- High Power Supply Ripple Rejection
- Stable During Pulse Charge Operation

#### **APPLICATIONS**

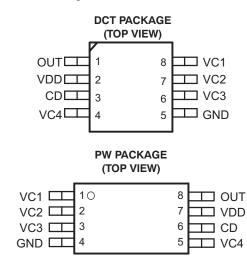
- 2<sup>nd</sup>-Level Overvoltage Protection in Li-lon Battery Packs in:
  - Notebook Computers
  - Portable Instrumentation
  - Portable Equipment

#### DESCRIPTION

The bq2941x is a secondary overvoltage protection IC for 2-, 3-, or 4-cell lithium-ion battery packs that incorporates a high-accuracy precision overvoltage detection circuit. It includes a programmable delay circuit for overvoltage detection time.

#### **FUNCTION**

Each cell in a multiple-cell pack is compared to an internal reference voltage. If one cell reaches an overvoltage condition, the protection sequence begins. The bq2941x device starts charging an external capacitor through the CD pin. When the CD pin voltage reaches 1.2 V, the OUT pin changes from a low level to a high level.





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.





These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

#### ORDERING INFORMATION<sup>(1)</sup>

| т              | V (2)                                 |              | PAC    | CKAGE <sup>(3)</sup>     |                            |
|----------------|---------------------------------------|--------------|--------|--------------------------|----------------------------|
| T <sub>A</sub> | V <sub>(PROTECT)</sub> <sup>(2)</sup> | MSOP (DCT)   | SYMBOL | SSOF                     | (PW)                       |
|                | 4.30 V                                | bq29419DCTR  | CJQ    | bg29419PWG4              | bq29419PWRG4               |
|                | 4.30 V                                | bq29419DCTT  | CJQ    | bq29419FWG4              | bq29419FVVKG4              |
|                |                                       | bq29410DCT3R |        |                          |                            |
| _              | 4.35 V                                | bq29410DCTR  | CJG    | bq29410PW<br>bq29410PWG4 | bq29410PWR<br>bg29410PWRG4 |
|                |                                       | bq29410DCTT  |        | 542011011101             | 54251101111101             |
|                |                                       | bq29411DCT3R |        |                          |                            |
|                | 4.40 V                                | bq29411DCTR  | CJH    | bq29411PW<br>bq29411PWG4 | bq29411PWR<br>bg29411PWRG4 |
|                |                                       | bq29411DCTT  |        | 54251111101              | 5425111111101              |
| -40°C to 110°C |                                       | bq29412DCT3R |        |                          |                            |
|                | 4.45 V                                | bq29412DCTR  | CJJ    | bq29412PW<br>bq29412PWG4 | bq29412PWR<br>bq29412PWRG4 |
|                |                                       | bq29412DCTT  |        | 54204121 ***             | 54254121 WICO4             |
|                | 4.50 V                                | bq29413DCTR  | CJk    | h~20442DW                | h~20442DWD                 |
|                | 4.50 V                                | bq29413DCTT  | CJK    | bq29413PW                | bq29413PWR                 |
|                | 4.55 V                                | bq29414DCTR  | CJL    | h~20444DW/               | h~20444DWD                 |
|                | 4.55 V                                | bq29414DCTT  | CJL    | bq29414PW                | bq29414PWR                 |
|                | 4.60 V                                | bq29415DCTR  | CJM    | h~20445DW                | h~2044EDWD                 |
|                | 4.00 V                                | bq29415DCTT  | CJIVI  | bq29415PW                | bq29415PWR                 |

<sup>(1)</sup> For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

#### **ABSOLUTE MAXIMUM RATINGS**

over operating free-air temperature range unless otherwise noted (1)(2)

|                           |  | UNIT                         |
|---------------------------|--|------------------------------|
| Supply voltage range      | VDD  | –0.3 V to 28 V               |
| Input voltage range       | VC1, VC2, VC3, VC4                             | –0.3 V to 28 V               |
| Input voltage range       | VC1 TO VC2, VC2 TO VC3, VC3 TO VC4, VC4 TO GND | -0.3 V to 8 V                |
| Output voltogo rongo      | OUT  | –0.3 V to 28 V               |
| Output voltage range      | CD   | –0.3 V to 28 V               |
| Continuous total power di | ssipation                                      | See Dissipation Rating Table |
| Storage temperature rang  | ge, T <sub>stg</sub>                           | −65°C to 150°C               |
| Lead temperature (solder  | ing, 10 s)                                     | 300°C                        |

<sup>(1)</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### PACKAGE DISSIPATION RATINGS

| PACKAGE | T <sub>A</sub> = 25°C<br>POWER RATING | DERATING FACTOR<br>ABOVE T <sub>A</sub> = 25°C | T <sub>A</sub> = 70°C<br>POWER RATING | T <sub>A</sub> = 85°C<br>POWER RATING |
|---------|---------------------------------------|--|---------------------------------------|---------------------------------------|
| DCT     | 412 mW                                | 3.3 mW/°C                                      | 264 mW                                | 214 mW                                |
| PW      | 525 mW                                | 4.2 mW/°C                                      | 336 mW                                | 273 mW                                |

<sup>(2)</sup> Contact your local Texas Instruments representative or sales office for alternative overvoltage threshold options.

<sup>(3)</sup> The "R" suffix indicates tape-and-reel packaging.

<sup>(2)</sup> All voltages are with respect to ground of this device except the differential voltage of VC1-VC2, VC2-VC3, VC3-VC4, and VC4-GND.





#### RECOMMENDED OPERATING CONDITIONS

|                    |                            |  | MIN  | NOM  | MAX | UNIT |
|--------------------|----------------------------|--|------|------|-----|------|
| $V_{DD}$           | Supply voltage             |  | 4    |      | 25  | V    |
| \/                 | Input voltage range        | VC1, VC2, VC3, VC4                     | 0    |      | 25  | V    |
| VI                 | Input voltage range        | VCn – VC (n=1), (n=1, 2, 3), VC4 – GND | 0    |      | 5   | v    |
| t <sub>d(CD)</sub> | Delay time capacitance     |  |      | 0.22 |     | μF   |
| R <sub>IN</sub>    | Voltage-monitor filter re- | sistance                               | 100  | 1k   |     | Ω    |
| C <sub>IN</sub>    | Voltage-monitor filter ca  | pacitance                              | 0.01 | 0.1  |     | μF   |
| $R_{VD}$           | Supply-voltage filter res  | istance                                | 0    |      | 1   | kΩ   |
| $C_{VD}$           | Supply-voltage filter cap  | pacitance                              |      | 0.1  |     | μF   |
| T <sub>A</sub>     | Operating ambient temp     | perature range                         | -40  |      | 110 | °C   |

#### **ELECTRICAL CHARACTERISTICS**

over recommended operating free-air temperature range,  $T_A = 25$ °C (unless otherwise noted)

|                        | PARAMETER                        | TEST CONDITION  | MIN | NOM  | MAX | UNIT |
|------------------------|----------------------------------|---|-----|------|-----|------|
|                        |                                  | T <sub>A</sub> = 25°C   |     | 25   | 35  |      |
| $V_{(OA)}$             | Overvoltage detection accuracy   | $T_A = -20$ °C to 85°C  |     | 25   | 50  | mV   |
|                        | accuracy                         | $T_A = -40$ °C to 110°C   |     |      | 80  |      |
|                        |                                  | bq29410   |     | 4.35 |     |      |
|                        |                                  | bq29411   |     | 4.40 |     |      |
|                        |                                  | bq29412   |     | 4.45 |     |      |
| V <sub>(PROTECT)</sub> | Overvoltage detection voltage    | bq29413   |     | 4.50 |     | V    |
|                        | detection voltage                | bq29414   |     | 4.55 |     |      |
|                        |                                  | bq29415   |     | 4.60 |     |      |
|                        |                                  | bq29419   |     | 4.30 |     |      |
|                        | Overvoltage detection            | bq29410/11/12/13/14/15  |     | 320  |     |      |
| $V_{hys}$              | hysteresis                       | bq29419   | 250 | 320  | 450 | mV   |
| I <sub>IN</sub>        | Input current                    | V2, V3 , VC4 input ,V <sub>DD</sub> = VC1<br>VC1 = VC2 = VC3 = VC4 = 3.5 V (see Figure 1)   |     |      | 0.3 | μΑ   |
| t <sub>D1</sub>        | Overvoltage detection delay time | V <sub>DD</sub> = VC1, CD = 0.22 μF   | 1   | 1.5  | 2   | s    |
| I <sub>(CD_dis)</sub>  | CD GND clamp current             | V <sub>DD</sub> = VC1, CD = 1 V   | 5   | 12   |     | μΑ   |
| 1                      | Cupply current                   | V <sub>DD</sub> = VC1,<br>VC1-VC2 = VC2-VC3 = VC3-VC4 = VC4-GND = 3.5 V<br>(see Figure 1)   |     | 2    | 3   |      |
| I <sub>CC</sub>        | Supply current                   | V <sub>DD</sub> = VC1,<br>VC1-VC2 = VC2-VC3 = VC3-VC4 = VC4-GND = 2.3 V<br>(see Figure 1)   |     | 1.5  | 2.5 | μA   |
| V                      | OUT pin drive voltage            | $VC1-VC2 = VC2-VC3 = VC3-VC4 = VC4-GND = V_{(PROTECT)}Max, V_{DD} = 14 V, I_{OH} = 0 mA$  |     | 7    |     | V    |
| V <sub>(OUT)</sub>     | Oo i piii urive voltage          | $ \begin{array}{l} VC1 = VC2 = VC3 = VC4 = V_{(PROTECT)}Max, \\ V_{DD} = 4.3 \text{ V, } T_{A} = 0^{\circ}\text{C to } 70^{\circ}\text{C, } I_{OH} = 40 \mu\text{A} \end{array} $ | 1.5 | 2    | 2.5 | V    |
| I <sub>OH</sub>        | High-level output current        | OUT = 3 V,<br>VC1-VC2 = VC2-VC3 = VC3-VC4 = VC4-GND =<br>V <sub>(PROTECT)</sub> Max, V <sub>DD</sub> = 14 V   |     |      | -1  | mA   |
| I <sub>OL</sub>        | Low-level output current         | OUT = 0.1 V, V <sub>DD</sub> = VC1,<br>VC1-VC2 = VC2-VC3 = VC3-VC4 = VC4-GND = 3.5 V  | 5   |      |     | μΑ   |



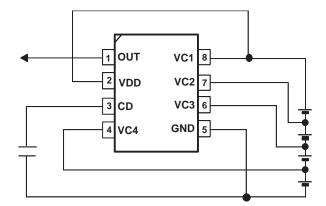


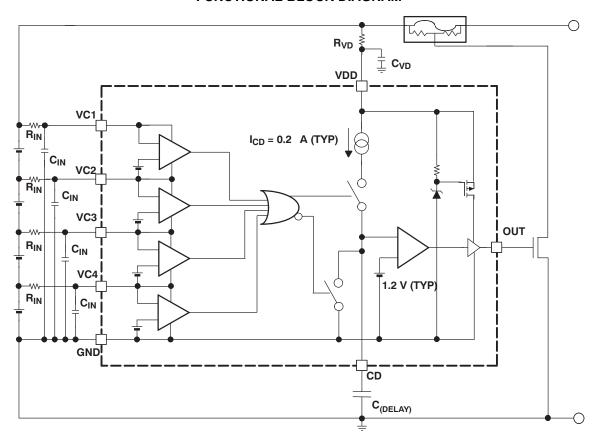
Figure 1.  $I_{CC}$ ,  $I_{IN}$  Measurement (DCT Package)

#### **Terminal Functions**

|               | TERMINAL      |      |   |  |  |  |  |  |  |
|---------------|---------------|------|---|--|--|--|--|--|--|
| MSOP<br>(DCT) | TSSOP<br>(PW) | NAME | DESCRIPTION   |  |  |  |  |  |  |
| 8             | 1             | VC1  | Sense voltage input for most positive cell                                  |  |  |  |  |  |  |
| 7             | 2             | VC2  | Sense voltage input for second most positive cell                           |  |  |  |  |  |  |
| 6             | 3             | VC3  | ense voltage input for third most positive cell                             |  |  |  |  |  |  |
| 5             | 4             | GND  | Ground pin  |  |  |  |  |  |  |
| 4             | 5             | VC4  | Sense voltage input for least positive cell                                 |  |  |  |  |  |  |
| 3             | 6             | CD   | An external capacitor is connected to determine the programmable delay time |  |  |  |  |  |  |
| 2             | 7             | VDD  | Power supply  |  |  |  |  |  |  |
| 1             | 8             | OUT  | Output  |  |  |  |  |  |  |



#### **FUNCTIONAL BLOCK DIAGRAM**



#### **OVERVOLTAGE PROTECTION**

When one of the cell voltages exceeds  $V_{(PROTECT)}$ , an internal current source begins to charge the capacitor,  $C_{(DELAY)}$ , connected to the CD pin. If the voltage at the CD pin,  $V_{CD}$ , reaches 1.2 V, the OUT pin is activated and transitions high. An externally connected NCH FET is activated and blows the external fuse in the positive battery rail; see the functional block diagram.

If all cell voltages fall below  $V_{(PROTECT)}$  before the voltage at pin CD reaches 1.2 V, the delay time does not run out. An internal switch clamps the CD pin to GND and discharges the capacitor,  $C_{(DELAY)}$ , and secures the full delay time for the next occurring overvoltage event.

Once the pin OUT is activated, it transitions back from high to low after all battery cells reach V<sub>(PROTECT)</sub> - V<sub>hvs.</sub>

#### **DELAY TIME CALCULATION**

The delay time is calculated as follows:

$$t_{d} = \frac{\left[1.2 \text{ V} \times \text{C}_{(DELAY)}\right]}{\text{I}_{CD}}$$
$$C_{(DELAY)} = \frac{\left[t_{d} \times \text{I}_{CD}\right]}{1.2 \text{ V}}$$

Where  $I_{(CD)} = CD$  current source = 0.18  $\mu$ A



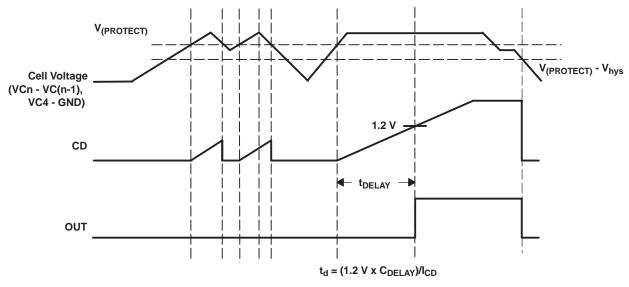


Figure 2. Timing for Overvoltage Sensing

#### **APPLICATION INFORMATION**

#### **BATTERY CONNECTIONS**

The following diagrams show the DCT package device in different cell configurations.

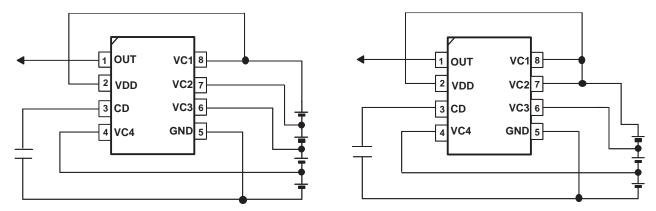


Figure 3. 4-Series Cell Configuration

Figure 4. 3-Series Cell Configuration (Connect together VC1 and VC2)



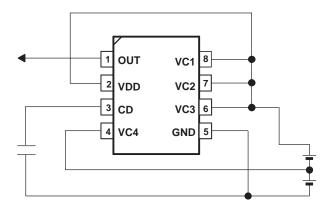


Figure 5. 2-Series Cell Configuration

#### **CELL CONNECTIONS**

To prevent incorrect output activation, the following connection sequences must be used.

#### 4-Series Cell Configuration

- $VC1(=VDD) \rightarrow VC2 \rightarrow VC3 \rightarrow VC4 \rightarrow GND$  or
- GND  $\rightarrow$  VC4  $\rightarrow$  VC3  $\rightarrow$  VC2  $\rightarrow$  VC1(=VDD)

#### 3-Series Cell Configuration

- $VC1(=VC2=VDD) \rightarrow VC3 \rightarrow VC4 \rightarrow GND$  or
- GND  $\rightarrow$  VC4  $\rightarrow$  VC3  $\rightarrow$  VC1(=VC2=VDD)

#### 2-Series Cell Configuration

- $VC1(=VC2=VC3=VDD) \rightarrow VC4 \rightarrow GND$  or
- GND → VC4 → VC1(=VC2=VC3=VDD)





11-Apr-2013

#### **PACKAGING INFORMATION**

| Orderable Device | Status | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp       | Op Temp (°C) | Top-Side Markings | Samples |
|------------------|--------|--------------|--------------------|------|----------------|----------------------------|------------------|---------------------|--------------|-------------------|---------|
| BQ29410DCT3R     | ACTIVE | SM8          | DCT                | 8    | 3000           | Pb-Free<br>(RoHS)          | CU SNBI          | Level-1-260C-UNLIM  | -40 to 110   | CJG<br>W          | Samples |
| BQ29410DCT3RE6   | ACTIVE | SM8          | DCT                | 8    | 3000           | Pb-Free<br>(RoHS)          | CU SNBI          | Level-1-260C-UNLIM  | -40 to 110   | CJG<br>W          | Samples |
| BQ29410DCTR      | ACTIVE | SM8          | DCT                | 8    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | CJG<br>W          | Samples |
| BQ29410DCTRG4    | ACTIVE | SM8          | DCT                | 8    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | CJG<br>W          | Samples |
| BQ29410DCTT      | ACTIVE | SM8          | DCT                | 8    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | CJG<br>W          | Samples |
| BQ29410DCTTG4    | ACTIVE | SM8          | DCT                | 8    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | CJG<br>W          | Samples |
| BQ29410PW        | ACTIVE | TSSOP        | PW                 | 8    | 150            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | 29410             | Samples |
| BQ29410PWR       | ACTIVE | TSSOP        | PW                 | 8    | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | 29410             | Samples |
| BQ29410PWRG4     | ACTIVE | TSSOP        | PW                 | 8    | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR | -40 to 110   | 29410             | Samples |
| BQ29411DCT3R     | ACTIVE | SM8          | DCT                | 8    | 3000           | Pb-Free<br>(RoHS)          | CU SNBI          | Level-1-260C-UNLIM  | -40 to 110   | M<br>CJH          | Samples |
| BQ29411DCT3RE6   | ACTIVE | SM8          | DCT                | 8    | 3000           | Pb-Free<br>(RoHS)          | CU SNBI          | Level-1-260C-UNLIM  | -40 to 110   | M<br>CJH          | Samples |
| BQ29411DCTR      | ACTIVE | SM8          | DCT                | 8    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | M<br>CJH          | Samples |
| BQ29411DCTRG4    | ACTIVE | SM8          | DCT                | 8    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | M<br>CJH          | Samples |
| BQ29411DCTT      | ACTIVE | SM8          | DCT                | 8    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | CJH               | Samples |
| BQ29411DCTTG4    | ACTIVE | SM8          | DCT                | 8    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | M<br>CJH          | Samples |
| BQ29411PW        | ACTIVE | TSSOP        | PW                 | 8    | 150            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | 29411             | Samples |
| BQ29411PWR       | ACTIVE | TSSOP        | PW                 | 8    | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | 29411             | Samples |





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| Orderable Device | Status  | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp       | Op Temp (°C) | Top-Side Markings | Samples |
|------------------|---------|--------------|--------------------|------|----------------|----------------------------|------------------|---------------------|--------------|-------------------|---------|
| BQ29411PWRG4     | ACTIVE  | TSSOP        | PW                 | 8    | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR | -40 to 110   | 29411             | Samples |
| BQ29412DCT3R     | ACTIVE  | SM8          | DCT                | 8    | 3000           | Pb-Free<br>(RoHS)          | CU SNBI          | Level-1-260C-UNLIM  | -40 to 110   | M<br>C11          | Samples |
| BQ29412DCT3RE6   | ACTIVE  | SM8          | DCT                | 8    | 3000           | Pb-Free<br>(RoHS)          | CU SNBI          | Level-1-260C-UNLIM  | -40 to 110   | M<br>C11          | Samples |
| BQ29412DCT3T     | PREVIEW | ,            |                    | 8    |                | TBD                        | Call TI          | Call TI             | -40 to 110   |                   |         |
| BQ29412DCTR      | ACTIVE  | SM8          | DCT                | 8    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | M<br>CJJ          | Samples |
| BQ29412DCTRG4    | ACTIVE  | SM8          | DCT                | 8    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | M<br>C11          | Samples |
| BQ29412DCTT      | ACTIVE  | SM8          | DCT                | 8    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | M<br>C11          | Samples |
| BQ29412DCTTG4    | ACTIVE  | SM8          | DCT                | 8    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | M<br>C11          | Samples |
| BQ29412PW        | ACTIVE  | TSSOP        | PW                 | 8    | 150            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | 29412             | Samples |
| BQ29412PWG4      | ACTIVE  | TSSOP        | PW                 | 8    | 150            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR | -40 to 110   | 29412             | Samples |
| BQ29412PWR       | ACTIVE  | TSSOP        | PW                 | 8    | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  |              | 29412             | Samples |
| BQ29412PWRG4     | ACTIVE  | TSSOP        | PW                 | 8    | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR |              | 29412             | Samples |
| BQ29413DCTR      | ACTIVE  | SM8          | DCT                | 8    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | CJK<br>W          | Samples |
| BQ29413DCTRG4    | ACTIVE  | SM8          | DCT                | 8    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | CJK<br>W          | Samples |
| BQ29413DCTT      | ACTIVE  | SM8          | DCT                | 8    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | CJK<br>W          | Samples |
| BQ29413DCTTG4    | ACTIVE  | SM8          | DCT                | 8    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | CJK<br>W          | Samples |
| BQ29413PW        | ACTIVE  | TSSOP        | PW                 | 8    | 150            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR | -40 to 110   | 29413             | Samples |
| BQ29413PWG4      | ACTIVE  | TSSOP        | PW                 | 8    | 150            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR | -40 to 110   | 29413             | Samples |





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| Orderable Device | Status | Package Type | -       | Pins | _    | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp       | Op Temp (°C) | Top-Side Markings | Samples |
|------------------|--------|--------------|---------|------|------|----------------------------|------------------|---------------------|--------------|-------------------|---------|
|                  | (1)    |              | Drawing |      | Qty  | (2)                        |                  | (3)                 |              | (4)               |         |
| BQ29413PWR       | ACTIVE | TSSOP        | PW      | 8    | 2000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR | -40 to 110   | 29413             | Samples |
| BQ29413PWRG4     | ACTIVE | TSSOP        | PW      | 8    | 2000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR | -40 to 110   | 29413             | Samples |
| BQ29414DCTR      | ACTIVE | SM8          | DCT     | 8    | 3000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | CJL<br>W          | Samples |
| BQ29414DCTRG4    | ACTIVE | SM8          | DCT     | 8    | 3000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | CJL<br>W          | Samples |
| BQ29414DCTT      | ACTIVE | SM8          | DCT     | 8    | 250  | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | CJL<br>W          | Samples |
| BQ29414DCTTG4    | ACTIVE | SM8          | DCT     | 8    | 250  | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | CJL<br>W          | Samples |
| BQ29414PW        | ACTIVE | TSSOP        | PW      | 8    | 150  | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR | -40 to 110   | 2914              | Samples |
| BQ29414PWG4      | ACTIVE | TSSOP        | PW      | 8    | 150  | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR | -40 to 110   | 2914              | Samples |
| BQ29414PWR       | ACTIVE | TSSOP        | PW      | 8    | 2000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR | -40 to 110   | 2914              | Samples |
| BQ29414PWRG4     | ACTIVE | TSSOP        | PW      | 8    | 2000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR | -40 to 110   | 2914              | Samples |
| BQ29415DCTR      | ACTIVE | SM8          | DCT     | 8    | 3000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | CJM<br>W          | Samples |
| BQ29415DCTRG4    | ACTIVE | SM8          | DCT     | 8    | 3000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | CJM<br>W          | Samples |
| BQ29415DCTT      | ACTIVE | SM8          | DCT     | 8    | 250  | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | CJM<br>W          | Samples |
| BQ29415DCTTG4    | ACTIVE | SM8          | DCT     | 8    | 250  | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM  | -40 to 110   | CJM<br>W          | Samples |
| BQ29415PW        | ACTIVE | TSSOP        | PW      | 8    | 150  | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR | -40 to 110   | 2915              | Samples |
| BQ29415PWG4      | ACTIVE | TSSOP        | PW      | 8    | 150  | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR | -40 to 110   | 2915              | Samples |
| BQ29415PWR       | ACTIVE | TSSOP        | PW      | 8    | 2000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR | -40 to 110   | 2915              | Samples |
| BQ29415PWRG4     | ACTIVE | TSSOP        | PW      | 8    | 2000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR | -40 to 110   | 2915              | Samples |



#### PACKAGE OPTION ADDENDUM

11-Apr-2013

| Orderable Device | Status | Package Type | _       |   | Package | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp       | Op Temp (°C) | Top-Side Markings | Samples |
|------------------|--------|--------------|---------|---|---------|----------------------------|------------------|---------------------|--------------|-------------------|---------|
|                  | (1)    |              | Drawing |   | Qty     | (2)                        |                  | (3)                 |              | (4)               |         |
| BQ29419PW        | ACTIVE | TSSOP        | PW      | 8 | 150     | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR | -40 to 110   | 29419             | Samples |
| BQ29419PWG4      | ACTIVE | TSSOP        | PW      | 8 | 150     | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR | -40 to 110   | 29419             | Samples |
| BQ29419PWR       | ACTIVE | TSSOP        | PW      | 8 | 2000    | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR | -40 to 110   | 29419             | Samples |
| BQ29419PWRG4     | ACTIVE | TSSOP        | PW      | 8 | 2000    | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR | -40 to 110   | 29419             | Samples |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

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PACKAGE MATERIALS INFORMATION

www.ti.com 11-Jun-2013

#### TAPE AND REEL INFORMATION



# TAPE DIMENSIONS KO P1 BO W Cavity A0

|    | Dimension designed to accommodate the component width     |
|----|---|
|    | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



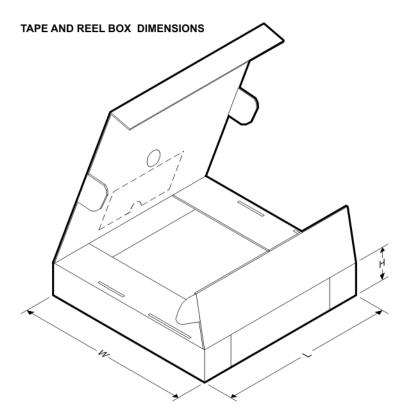
#### \*All dimensions are nominal

| Device       | Package<br>Type | Package<br>Drawing | Pins | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|--------------|-----------------|--------------------|------|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| BQ29410DCT3R | SM8             | DCT                | 8    | 3000 | 180.0                    | 13.0                     | 3.35       | 4.5        | 1.55       | 4.0        | 12.0      | Q3               |
| BQ29410DCTR  | SM8             | DCT                | 8    | 3000 | 180.0                    | 13.0                     | 3.35       | 4.5        | 1.55       | 4.0        | 12.0      | Q3               |
| BQ29410DCTT  | SM8             | DCT                | 8    | 250  | 180.0                    | 13.0                     | 3.35       | 4.5        | 1.55       | 4.0        | 12.0      | Q3               |
| BQ29410PWR   | TSSOP           | PW                 | 8    | 2000 | 330.0                    | 12.4                     | 7.0        | 3.6        | 1.6        | 8.0        | 12.0      | Q1               |
| BQ29410PWRG4 | TSSOP           | PW                 | 8    | 2000 | 330.0                    | 12.4                     | 7.0        | 3.6        | 1.6        | 8.0        | 12.0      | Q1               |
| BQ29411DCT3R | SM8             | DCT                | 8    | 3000 | 180.0                    | 13.0                     | 3.35       | 4.5        | 1.55       | 4.0        | 12.0      | Q3               |
| BQ29411DCTR  | SM8             | DCT                | 8    | 3000 | 180.0                    | 13.0                     | 3.35       | 4.5        | 1.55       | 4.0        | 12.0      | Q3               |
| BQ29411DCTT  | SM8             | DCT                | 8    | 250  | 180.0                    | 13.0                     | 3.35       | 4.5        | 1.55       | 4.0        | 12.0      | Q3               |
| BQ29411PWR   | TSSOP           | PW                 | 8    | 2000 | 330.0                    | 12.4                     | 7.0        | 3.6        | 1.6        | 8.0        | 12.0      | Q1               |
| BQ29411PWRG4 | TSSOP           | PW                 | 8    | 2000 | 330.0                    | 12.4                     | 7.0        | 3.6        | 1.6        | 8.0        | 12.0      | Q1               |
| BQ29412DCTR  | SM8             | DCT                | 8    | 3000 | 180.0                    | 13.0                     | 3.35       | 4.5        | 1.55       | 4.0        | 12.0      | Q3               |
| BQ29412DCTT  | SM8             | DCT                | 8    | 250  | 180.0                    | 13.0                     | 3.35       | 4.5        | 1.55       | 4.0        | 12.0      | Q3               |
| BQ29412PWR   | TSSOP           | PW                 | 8    | 2000 | 330.0                    | 12.4                     | 7.0        | 3.6        | 1.6        | 8.0        | 12.0      | Q1               |
| BQ29412PWRG4 | TSSOP           | PW                 | 8    | 2000 | 330.0                    | 12.4                     | 7.0        | 3.6        | 1.6        | 8.0        | 12.0      | Q1               |
| BQ29413DCTR  | SM8             | DCT                | 8    | 3000 | 180.0                    | 13.0                     | 3.35       | 4.5        | 1.55       | 4.0        | 12.0      | Q3               |
| BQ29413DCTT  | SM8             | DCT                | 8    | 250  | 180.0                    | 13.0                     | 3.35       | 4.5        | 1.55       | 4.0        | 12.0      | Q3               |
| BQ29413PWR   | TSSOP           | PW                 | 8    | 2000 | 330.0                    | 12.4                     | 7.0        | 3.6        | 1.6        | 8.0        | 12.0      | Q1               |
| BQ29414DCTR  | SM8             | DCT                | 8    | 3000 | 180.0                    | 13.0                     | 3.35       | 4.5        | 1.55       | 4.0        | 12.0      | Q3               |

# **PACKAGE MATERIALS INFORMATION**

www.ti.com 11-Jun-2013

| Device      | Package<br>Type | Package<br>Drawing |   | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-------------|-----------------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| BQ29414DCTT | SM8             | DCT                | 8 | 250  | 180.0                    | 13.0                     | 3.35       | 4.5        | 1.55       | 4.0        | 12.0      | Q3               |
| BQ29414PWR  | TSSOP           | PW                 | 8 | 2000 | 330.0                    | 12.4                     | 7.0        | 3.6        | 1.6        | 8.0        | 12.0      | Q1               |
| BQ29415DCTR | SM8             | DCT                | 8 | 3000 | 180.0                    | 13.0                     | 3.35       | 4.5        | 1.55       | 4.0        | 12.0      | Q3               |
| BQ29415DCTT | SM8             | DCT                | 8 | 250  | 180.0                    | 13.0                     | 3.35       | 4.5        | 1.55       | 4.0        | 12.0      | Q3               |
| BQ29415PWR  | TSSOP           | PW                 | 8 | 2000 | 330.0                    | 12.4                     | 7.0        | 3.6        | 1.6        | 8.0        | 12.0      | Q1               |
| BQ29419PWR  | TSSOP           | PW                 | 8 | 2000 | 330.0                    | 12.4                     | 7.0        | 3.6        | 1.6        | 8.0        | 12.0      | Q1               |



#### \*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| BQ29410DCT3R | SM8          | DCT             | 8    | 3000 | 182.0       | 182.0      | 20.0        |
| BQ29410DCTR  | SM8          | DCT             | 8    | 3000 | 182.0       | 182.0      | 20.0        |
| BQ29410DCTT  | SM8          | DCT             | 8    | 250  | 182.0       | 182.0      | 20.0        |
| BQ29410PWR   | TSSOP        | PW              | 8    | 2000 | 367.0       | 367.0      | 35.0        |
| BQ29410PWRG4 | TSSOP        | PW              | 8    | 2000 | 367.0       | 367.0      | 35.0        |
| BQ29411DCT3R | SM8          | DCT             | 8    | 3000 | 182.0       | 182.0      | 20.0        |
| BQ29411DCTR  | SM8          | DCT             | 8    | 3000 | 182.0       | 182.0      | 20.0        |
| BQ29411DCTT  | SM8          | DCT             | 8    | 250  | 182.0       | 182.0      | 20.0        |
| BQ29411PWR   | TSSOP        | PW              | 8    | 2000 | 367.0       | 367.0      | 35.0        |
| BQ29411PWRG4 | TSSOP        | PW              | 8    | 2000 | 367.0       | 367.0      | 35.0        |
| BQ29412DCTR  | SM8          | DCT             | 8    | 3000 | 182.0       | 182.0      | 20.0        |



# **PACKAGE MATERIALS INFORMATION**

www.ti.com 11-Jun-2013

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| BQ29412DCTT  | SM8          | DCT             | 8    | 250  | 182.0       | 182.0      | 20.0        |
| BQ29412PWR   | TSSOP        | PW              | 8    | 2000 | 367.0       | 367.0      | 35.0        |
| BQ29412PWRG4 | TSSOP        | PW              | 8    | 2000 | 367.0       | 367.0      | 35.0        |
| BQ29413DCTR  | SM8          | DCT             | 8    | 3000 | 182.0       | 182.0      | 20.0        |
| BQ29413DCTT  | SM8          | DCT             | 8    | 250  | 182.0       | 182.0      | 20.0        |
| BQ29413PWR   | TSSOP        | PW              | 8    | 2000 | 367.0       | 367.0      | 35.0        |
| BQ29414DCTR  | SM8          | DCT             | 8    | 3000 | 182.0       | 182.0      | 20.0        |
| BQ29414DCTT  | SM8          | DCT             | 8    | 250  | 182.0       | 182.0      | 20.0        |
| BQ29414PWR   | TSSOP        | PW              | 8    | 2000 | 367.0       | 367.0      | 35.0        |
| BQ29415DCTR  | SM8          | DCT             | 8    | 3000 | 182.0       | 182.0      | 20.0        |
| BQ29415DCTT  | SM8          | DCT             | 8    | 250  | 182.0       | 182.0      | 20.0        |
| BQ29415PWR   | TSSOP        | PW              | 8    | 2000 | 367.0       | 367.0      | 35.0        |
| BQ29419PWR   | TSSOP        | PW              | 8    | 2000 | 367.0       | 367.0      | 35.0        |

#### DCT (R-PDSO-G8)

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion
- D. Falls within JEDEC MO-187 variation DA.

# DCT (R-PDSO-G8)

#### PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



PW (R-PDSO-G8)

#### PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M—1994.
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
- E. Falls within JEDEC MO-153



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